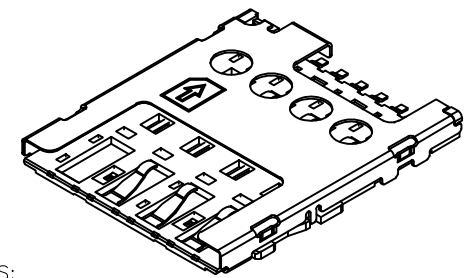
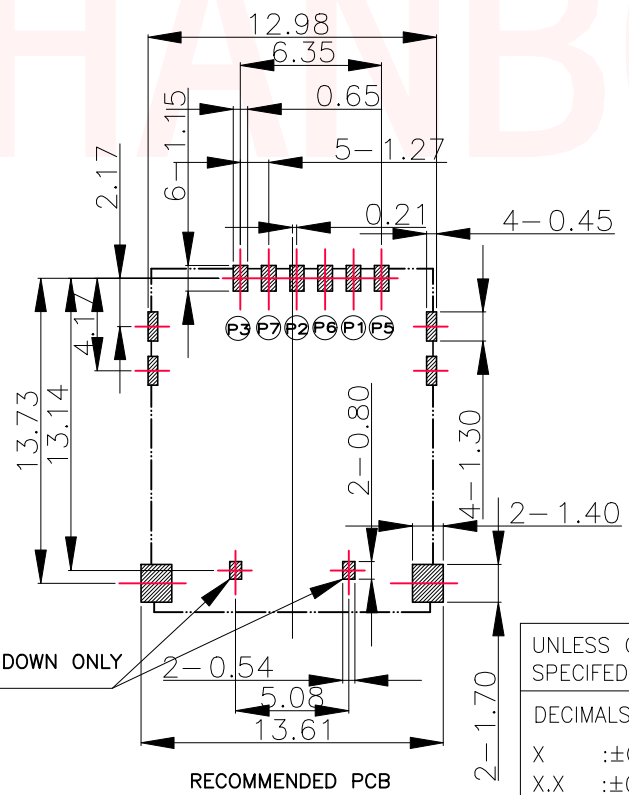
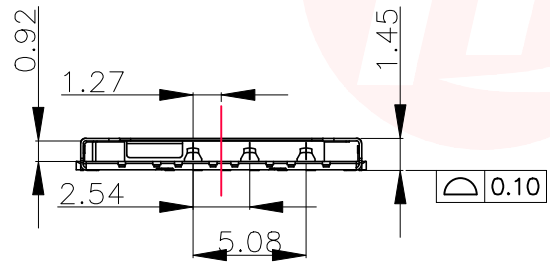
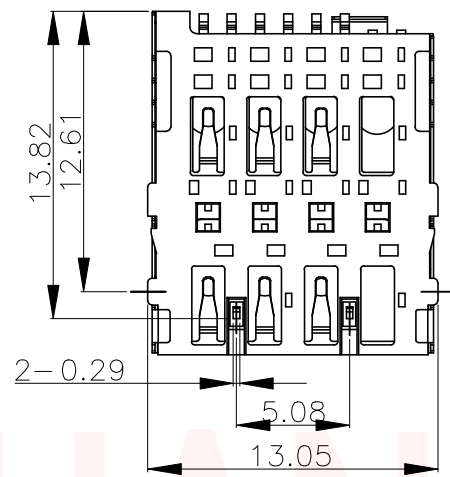
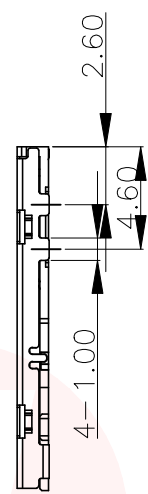
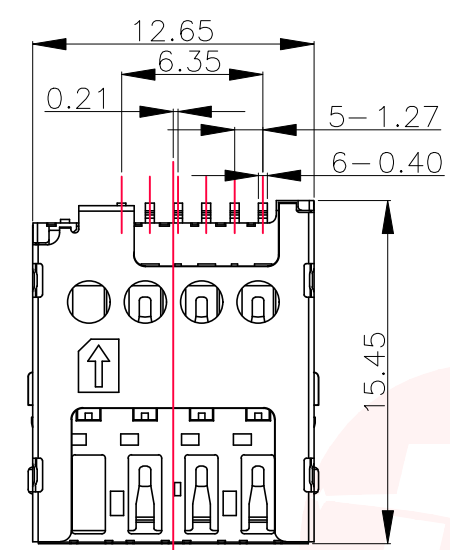




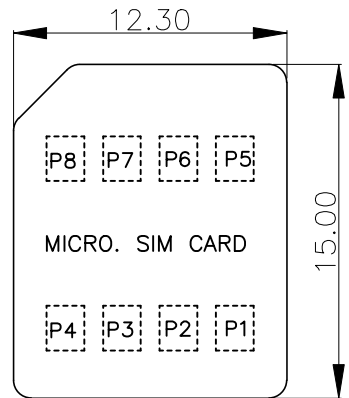
REV.	ECN NO OR DESCRIPTION	REVISED	DATE



NOTES:
 1) MATERIAL
 HOUSING LCP UL 94V-0
 CONTACT C5210
 SHELL SUS304
 2) FINISH:
 CONTACT GOLD FLASH PLATED ON CONTACT AREA;
 GOLD FLASH PLATING ON SOLDER
 WITH ENTIRE CONTACT UNDERPLATED NICKEL
 SHELL: NICKEL UNDERPLATED OVERALL
 GOLD FLASH PLATED ON SOLDER TAILS

- 3) ELECTRICAL SPECIFICATIONS:
 CURRENT RATING: 0.5A.
 VOLTAGE RATING: 5V.
 CONTACT RESISTANCE: 50 MILLIOHM MAX.
 INSULATION RESISTANCE: 1000 MEG.OHM MIN.
 4) MECHANICAL SPECIFICATIONS:
 DURABILITY: 3000 CYCLES MIN.

Pin1:VCC
Pin2:RST
Pin3:CLK
Pin4:Reserved
Pin5:GND
Pin6:VPP
Pin7:I/O
Pin8:Reserved



NOT GND FOR HOLD-DOWN ONLY

RECOMMENDED PCB LAYOUT

TOLERANCE: ±0.05

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:	ANGLES:
X :±0.30	X :±2°
X.X :±0.20	X.X :±1°
X.XX :±0.10	

东莞市汉博电子科技有限公司
 DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	1.45H MICRO SIM CARD CONNECTOR			
DWN	xiong	PART NO. SMO-1027-P6		
CHKD	lee	SCALE: 1:1	UNIT: mm	
APVD	wang	SIZE: A4	SHEET: 10F 1	REV: A4
CUSTOMER COPY				